



Atty. Dkt. No. 047071-0107

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Harry A. ATWATER, Jr. et al.
Title: WAFER BONDED VIRTUAL SUBSTRATE AND
METHOD FOR FORMING THE SAME
Appl. No.: 10/761,918
Filing Date: 1/20/2004
Examiner: Duy-Vu DEO
Art Unit: 1765
Confirmation Number: 4108

OK to
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AMENDMENT AND REPLY UNDER 37 CFR 1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This communication is responsive to the Final Office Action dated November 7, 2006, concerning the above-referenced patent application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this document.

Remarks/Arguments begin on page 5 of this document.

Please amend the application as follows: